# HPFS® Fused Silica ArF Grade





Semiconductor
Optics

HPFS® ArF Grade, Corning code 7980, is a high purity synthetic amorphous silicon dioxide manufactured by flame hydrolysis. The noncrystalline, colorless, silica glass combines a very low thermal expansion coefficient with excellent optical qualities and exceptional transmittance in the deep ultraviolet. ArF Grade was developed for 193 nm lithography systems.

In order to satisfy the challenging quality requirements of our customers in leading edge applications such as microlithography, Corning is dedicated to continuous improvement. Our investments in research and development, combined with Corning's quality systems, support our technology leadership position and ensure that we meet our customer's requirements on time, every time.

### Quality Grade Selection Chart—HPFS® ArF Grade

Corning defines and certifies the quality of HPFS® glass using two criteria: inclusions and homogeneity grade.

	Inclusion Class		Homogeneity 3,4 ppm			
			Grade			
Class	Total inclusion <sup>1</sup> cross section [mm <sup>2</sup> ]	Maximum <sup>2</sup> size [mm]	AA ≤ 0.5	A ≤ 1	C ≤ 2	F ≤ 5
0	≤ 0.03	0.10	•			
1	≤ 0.10	0.28				
2	≤ 0.25	0.50				

#### Notes:

- 1. Defines the sum of the cross section in  $mm^2$  of inclusions per 100 cm<sup>3</sup> of glass. Inclusions with a diameter  $\leq 0.10$  mm are disregarded.
- 2. Refers to the diameter of the largest single inclusion.
- 3. Index homogeneity: the maximum index variation (relative), measured over the clear aperture of the blank.
- 4. Index homogeneity is certified using an interferometer at 632.8 nm. The numerical homogeneity is reported as the average through the piece thickness. Blanks with diameter up to 450 mm can be analyzed over the full aperture. Larger parts can be analyzed using multiple overlapping apertures. The minimum thickness for index homogeneity verification is 20 mm. For thinner parts, the parent piece is certified.

### **Mechanical & Thermal Properties**

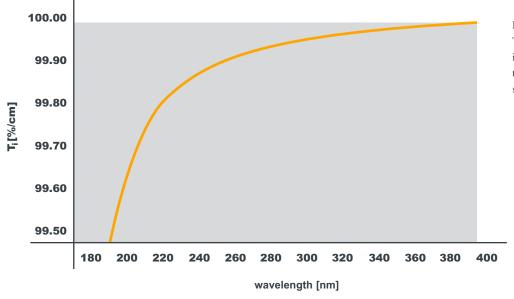
Unless otherwise stated, all values @25 °C

Elastic (Young's) Modulus	72.7 GPa	Softening Point	1585 °C (10 <sup>7.6</sup> poises)		
Shear Modulus	31.4 GPa	Annealing Point	104	1042 °C (10 <sup>13</sup> poises)	
Average Modulus of Rupture, abraded	52.4 MPa	Strain Point	893 °C (10 <sup>14.5</sup> poises)		
Bulk Modulus	35.4 GPa	Thermal Conductivity		1.30 W/m K	
Poisson's Ratio	0.16	Thermal Diffusivity		0.0075 cm <sup>2</sup> /s	
Density	2.201 g/cm <sup>3</sup>	Average C.T.E.	0.52 ppm/K	5°C-35 °C	
Knoop Hardness (100 g load)	522 kg/mm <sup>2</sup>		0.57 ppm/K	0°C-200°C	
			0.48 ppm/K	-100°C-200°C	

### **Chemical durability and Impurities**

Solution		Time	Weight Loss [mg/cm <sup>2</sup> ]	Impurities
5% HCL by weight	@95 °C	24 h	< 0.010	OH content (by weight): 800 – 1000 ppm
5% NaOH	@95 ℃	6 h	0.453	Impurities other than OH: <100 ppb
0.02N NA <sub>2</sub> CO <sub>3</sub>	@95 ℃	6 h	0.065	
0.02N H <sub>2</sub> SO <sub>4</sub>	@95 ℃	24 h	< 0.010	
Deionized H <sub>2</sub> O	@95 ℃	24 h	0.015	
10% HF by weight	@25 °C	20 m	0.230	
10% NH <sub>4</sub> F*HF by weight	@25 °C	20 m	0.220	

### Internal transmittance



HPFS® ArF Grade is certified to meet  $T_{\rm i} \geq 99.5\%/cm@193nm. \mbox{Higher transmittance}$  is available upon request. A typical internal transmittance curve for HPFS® ArF Grade fused silica is shown here.

### Refractive index and dispersion

Data in 22 °C in 760mm Hg dry nitrogen gas

Wavelength	Refractive	Thermal	Polynomial Dispersion Equation Constants *1	
[air]	Index *2	Coefficient $\Delta n/\Delta T^{*3}$ (ppm/K)	A <sub>0</sub> 2.104025406	
λ [nm]	n	ΔII/Δ1 * (ppiii/K)	- 1.456000330 x 10 <sup>-4</sup>	
1128.64	1.448870	9.6	_ A <sub>2</sub> -9.049135390 x 10 <sup>-3</sup>	
1064.00	1.449633	9.6	A <sub>3</sub> 8.801830992 x 10 <sup>-3</sup>	
1060.00	1.449681	9.6	A <sub>4</sub> 8.435237228 x 10 <sup>-5</sup>	
1013.98 n <sub>t</sub>	1.450245	9.6	A <sub>5</sub> 1.681656789 x 10 <sup>-6</sup>	
852.11 n <sub>s</sub>	1.452469	9.7	-1.675425449 x 10 <sup>-8</sup>	
706.52 n <sub>r</sub>	1.455149	9.9	A <sub>7</sub> 8.326602461 x 10 <sup>-10</sup>	
656.27 n <sub>c</sub>	1.456370	9.9		
643.85 n <sub>c′</sub>	1.456707	10.0	Sellmeier Dispersion Equation Constants *2	
$632.80 \; n_{\text{He-Ne}}$	1.457021	10.0	B <sub>1</sub> 0.68374049400	
589.29 n <sub>d</sub>	1.458406	10.1	B <sub>2</sub> 0.42032361300	
587.56 n <sub>d</sub>	1.458467	10.1	B <sub>3</sub> 0.58502748000	
546.07 n <sub>e</sub>	1.460082	10.2	C <sub>1</sub> 0.00460352869	
486.13 n <sub>F</sub>	1.463132	10.4	$C_2$ 0.01339688560	
479.99 n <sub>F</sub>	1.463509	10.4	C <sub>3</sub> 64.49327320000	
435.83 n <sub>g</sub>	1.466701	10.6	A./AT.D Constant 83	
404.66 n <sub>h</sub>	1.469628	10.8	Δn/ΔT Dispersion Equation Constants *3	
365.01 n <sub>i</sub>	1.474555	11.2	$C_0$ 9.390590	
334.15	1.479785	11.6	$C_1$ 0.235290	
312.57	1.484514	12.0	$C_2$ -1.318560 x 10 <sup>-3</sup>	
308.00	1.485663	12.1	$C_3$ 3.028870 x 10 <sup>-4</sup>	
248.30	1.508433	14.2	Other Optical Properties	
248.00	1.508601	14.2		
214.44	1.533789	17.0	$v_{\rm d}$ 67.79	
206.20	1.542741	18.1	$v_{\rm e}$ 67.64	
194.17	1.559012	20.4	$n_{\rm F} - n_{\rm C}$ 0.006763	
193.40	1.560208	20.5	$n_{F} - n_{C}$ 0.006802	
193.00	1.560841	20.6	Stress Coefficient 35.0 nm/cm MPa	
184.89	1.575131	22.7	Striae ISO 10110-4 Class 5/Thickness Direction	
			Birefringence ≤ 1nm/cm, lower specifications available	

<sup>\*1</sup> Polynomial Equation:  $n^2 = A_0 + A_1 \ \lambda^4 + A_2 \ \lambda^2 + A_3 \ \lambda^{-2} + A_4 \ \lambda^{-4} + A_5 \ \lambda^{-6} + A_6 \ \lambda^{-8} + A_7 \ \lambda^{-10}$  with  $\lambda$  in  $\mu$ m \*2 Sellmeier Equation:  $n^2$ -1 =  $B_1 \ \lambda^2/(\lambda^2$ - $C_1) + B_2 \ \lambda^2/(\lambda^2$ - $C_2) + B_3 \ \lambda^2/(\lambda^2$ - $C_3)$  with  $\lambda$  in  $\mu$ m

## Resistance to laser damage

Samples of HPFS® ArF Grade are regularly tested at Corning's Metrology Laboratory, Sullivan Park Research Center, to maintain the high standards to which Corning is committed.

<sup>\*3</sup>  $\Delta$ n/ $\Delta$ T Equation (20–25°C) =  $C_0 + C_1 \lambda^2 + C_2 \lambda^4 + C_3 \lambda^6$  with  $\lambda$  in  $\mu$ m

We are here to help you specify the best product for your application. For further information, please contact:

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